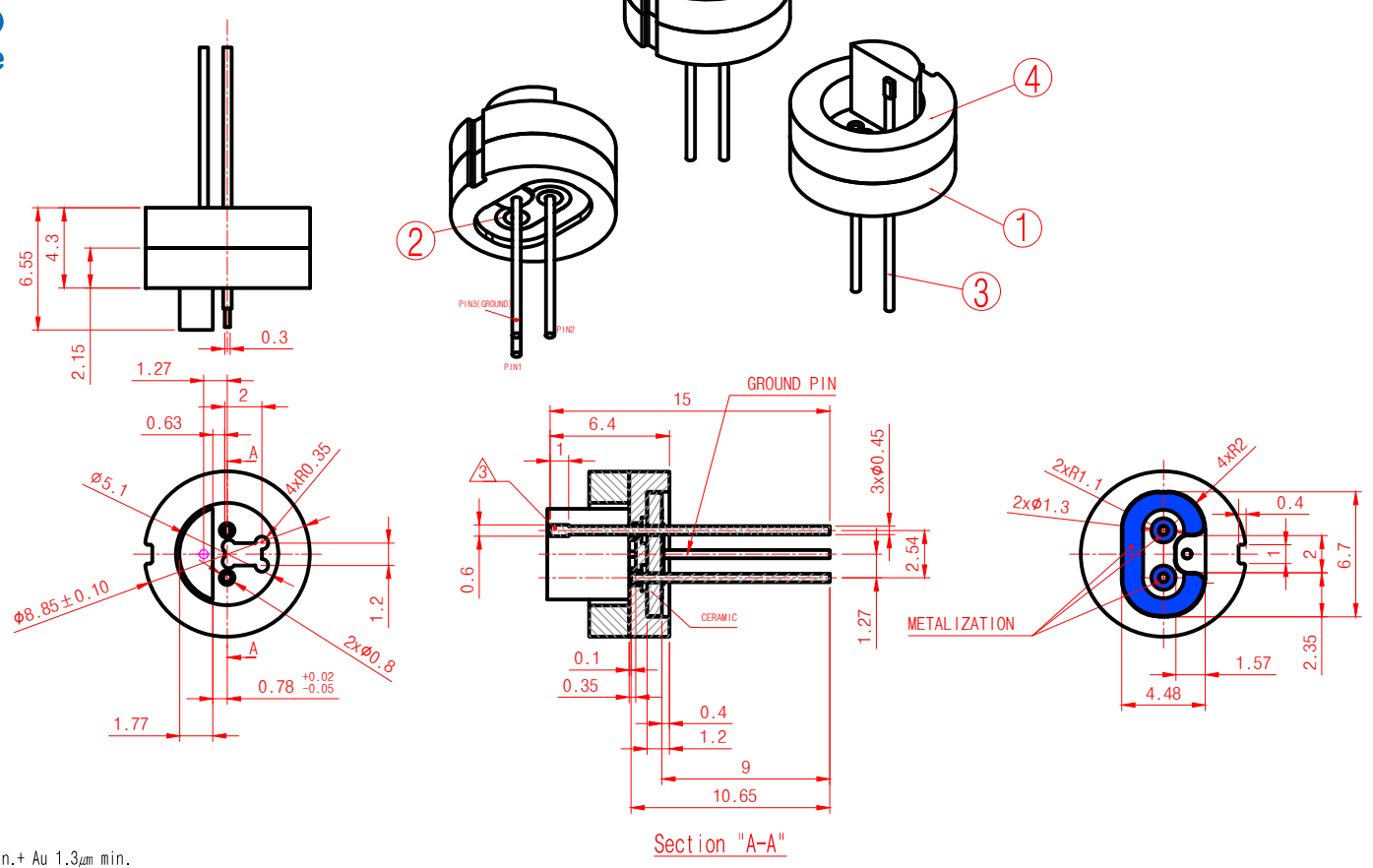




REVISIONS			
REV.	DESCRIPTION	DATE	APPROVED
A	Design Change	2021-01-26	KANG, E. C.



- NOTES:**
1. FINISH : Ni 2-6 μm min.+ Au 1.3 μm min.
 2. Allow non-plating by racking and plating wire.
 3. THE METALLIZATION POST PIN WIRE BOND AREA SHOULD BE WIREBONDABLE
 4. THE PINS SHOULD BE SOLDERED STRONG ENOUGH TO MAINTAIN THEM NOT PULL OFF
 5. MISSING DIMENSIONS PER CAD FILE

TABLE(BILL OF MATERIALS)

ITEM	DESCRIPTION	MATERIAL	QTY	Tolerances unless otherwise specified : $\pm 0.1\text{mm}$		MATERIAL : SEE BOM TABLE
1	STEM	OFHC	1	DATE	NAME	TITLE :
2	CERAMIC EYELET	Al ₂ O ₃ 96%	1	DESIGNED BY	2021-01-26	JUNG, E. T.
3	PIN 1,2,3	Kovar	3	CHECKED BY	2021-01-26	PACK, M. Y.
4	SPC RING	SPC	1	APPROVED BY	2021-01-26	KANG, E. C.
				DWG. No.	G45-32-A00A	Unit mm
				Rev.	A	

TO9 HIGH POWER HEADER.. 0.78mm GAP